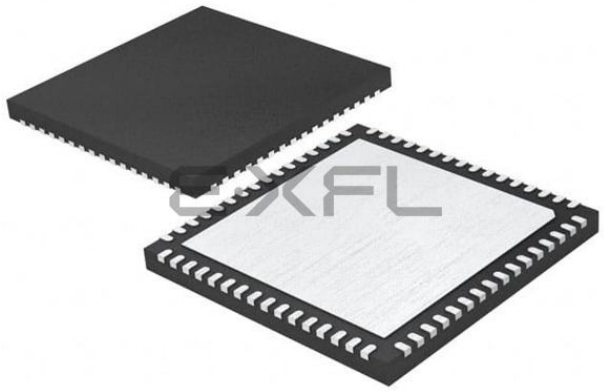

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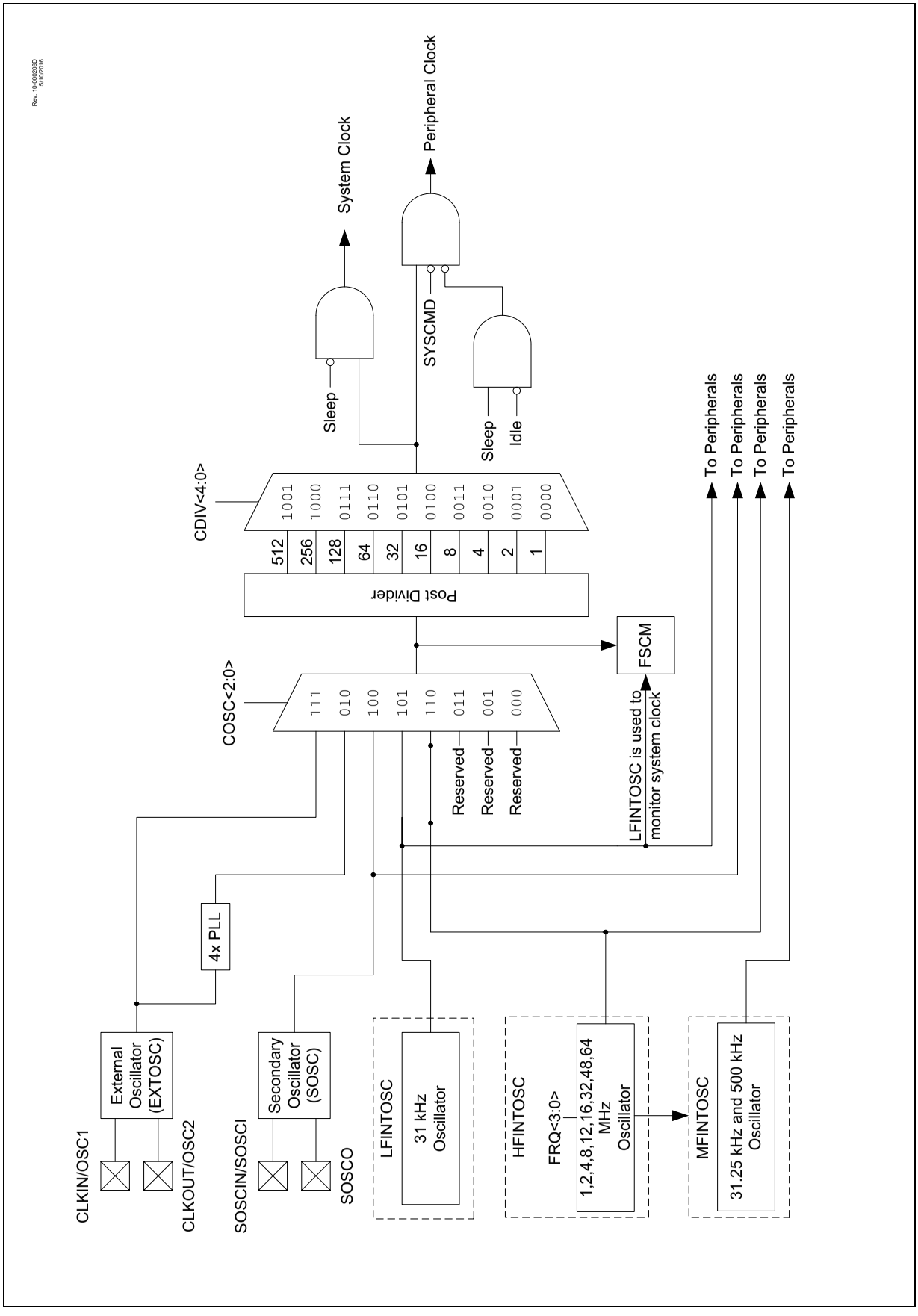
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	60
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	1K x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 45x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-VFQFN Exposed Pad
Supplier Device Package	64-VQFN (9x9)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f65k40t-i-mr

FIGURE 4-1: SIMPLIFIED PIC® MCU CLOCK SOURCE BLOCK DIAGRAM



EXAMPLE 11-3: ERASING A PROGRAM FLASH MEMORY BLOCK

```
; This sample row erase routine assumes the following:
; 1. A valid address within the erase row is loaded in variables TBLPTR register
; 2. ADDRH and ADDRL are located in common RAM (locations 0x70 - 0x7F)

            MOVLW       CODE_ADDR_UPPER    ; load TBLPTR with the base
            MOVWF       TBLPTRU            ; address of the memory block
            MOVLW       CODE_ADDR_HIGH
            MOVWF       TBLPTRH
            MOVLW       CODE_ADDR_LOW
            MOVWF       TBLPTRL
ERASE_BLOCK
            BCF         NVMCON1, NVMREG0   ; point to Program Flash Memory
            BSF         NVMCON1, NVMREG1   ; access Program Flash Memory
            BSF         NVMCON1, WREN      ; enable write to memory
            BSF         NVMCON1, FREE      ; enable block Erase operation
            BCF         INTCON, GIE        ; disable interrupts
Required    MOVLW       55h
Sequence    MOVWF       NVMCON2            ; write 55h
            MOVLW       AAh
            MOVWF       NVMCON2            ; write AAh
            BSF         NVMCON1, WR        ; start erase (CPU stalls)
            BSF         INTCON, GIE        ; re-enable interrupts
```

12.0 8x8 HARDWARE MULTIPLIER

12.1 Introduction

All PIC18 devices include an 8x8 hardware multiplier as part of the ALU. The multiplier performs an unsigned operation and yields a 16-bit result that is stored in the product register pair, PRODH:PRODL. The multiplier's operation does not affect any flags in the STATUS register.

Making multiplication a hardware operation allows it to be completed in a single instruction cycle. This has the advantages of higher computational throughput and reduced code size for multiplication algorithms and allows the PIC18 devices to be used in many applications previously reserved for digital signal processors. A comparison of various hardware and software multiply operations, along with the savings in memory and execution time, is shown in Table 12-1.

12.2 Operation

Example 12-1 shows the instruction sequence for an 8x8 unsigned multiplication. Only one instruction is required when one of the arguments is already loaded in the WREG register.

Example 12-2 shows the sequence to do an 8x8 signed multiplication. To account for the sign bits of the arguments, each argument's Most Significant bit (MSb) is tested and the appropriate subtractions are done.

EXAMPLE 12-1: 8x8 UNSIGNED MULTIPLY ROUTINE

```
MOVF   ARG1, W   ;
MULWF  ARG2      ; ARG1 * ARG2 ->
                 ; PRODH:PRODL
```

EXAMPLE 12-2: 8x8 SIGNED MULTIPLY ROUTINE

```
MOVF   ARG1, W
MULWF  ARG2      ; ARG1 * ARG2 ->
                 ; PRODH:PRODL
BTFSC  ARG2, SB  ; Test Sign Bit
SUBWF  PRODH, F  ; PRODH = PRODH
                 ;          - ARG1
MOVF   ARG2, W
BTFSC  ARG1, SB  ; Test Sign Bit
SUBWF  PRODH, F  ; PRODH = PRODH
                 ;          - ARG2
```

TABLE 12-1: PERFORMANCE COMPARISON FOR VARIOUS MULTIPLY OPERATIONS

Routine	Multiply Method	Program Memory (Words)	Cycles (Max)	Time			
				@ 64 MHz	@ 40 MHz	@ 10 MHz	@ 4 MHz
8x8 unsigned	Without hardware multiply	13	69	4.3 μs	6.9 μs	27.6 μs	69 μs
	Hardware multiply	1	1	62.5 ns	100 ns	400 ns	1 μs
8x8 signed	Without hardware multiply	33	91	5.7 μs	9.1 μs	36.4 μs	91 μs
	Hardware multiply	6	6	375 ns	600 ns	2.4 μs	6 μs
16x16 unsigned	Without hardware multiply	21	242	15.1 μs	24.2 μs	96.8 μs	242 μs
	Hardware multiply	28	28	1.8 μs	2.8 μs	11.2 μs	28 μs
16x16 signed	Without hardware multiply	52	254	15.9 μs	25.4 μs	102.6 μs	254 μs
	Hardware multiply	35	40	2.5 μs	4.0 μs	16.0 μs	40 μs

REGISTER 15-6: ODCONx: OPEN-DRAIN CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
ODCx7	ODCx6	ODCx5	ODCx4	ODCx3	ODCx2	ODCx1	ODCx0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown
-n/n = Value at POR and BOR/Value at all other Resets		

bit 7-0 **ODCx<7:0>**: Open-Drain Configuration on Pins Rx<7:0>

1 = Output drives only low-going signals (sink current only)

0 = Output drives both high-going and low-going signals (source and sink current)

TABLE 15-6: OPEN-DRAIN CONTROL REGISTERS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
ODCONA	ODCONA7	ODCONA6	ODCONA5	ODCONA4	ODCONA3	ODCONA2	ODCONA1	ODCONA0
ODCONB	ODCONB7	ODCONB6	ODCONB5	ODCONB4	ODCONB3	ODCONB2	ODCONB1	ODCONB0
ODCONC	ODCONC7	ODCONC6	ODCONC5	ODCONC4	ODCONC3	ODCONC2	ODCONC1	ODCONC0
ODCOND	ODCOND7	ODCOND6	ODCOND5	ODCOND4	ODCOND3	ODCOND2	ODCOND1	ODCOND0
ODCONE	ODCONE7	ODCONE6	ODCONE5	ODCONE4	ODCONE3	ODCONE2	ODCONE1	ODCONE0
ODCONF	ODCONF7	ODCONF6	ODCONF5	ODCONF4	ODCONF3	ODCONF2	ODCONF1	ODCONF0
ODCONG	ODCONG7	ODCONG6	—	ODCONG4	ODCONG3	ODCONG2	ODCONG1	ODCONG0
ODCONH	—	—	—	—	ODCONH3	ODCONH2	ODCONH1	ODCONH0

TABLE 17-2: SUMMARY OF REGISTERS ASSOCIATED WITH THE PPS MODULE (CONTINUED)

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on page
MDCARLPPS	—	—	MDCARLPPS<5:0>						225
MDCARHPPS	—	—	MDCARHPPS<5:0>						225
MDSRCPPS	—	—	MDSRCPPS<5:0>						225
ADACTPPS	—	—	ADACTPPS<5:0>						225
SSP1CLKPPS	—	—	SSP1CLKPPS<5:0>						225
SSP1DATPPS	—	—	SSP1DATPPS<5:0>						225
SSP1SSPPS	—	—	SSP1SSPPS<5:0>						225
SSP2CLKPPS	—	—	SSP2CLKPPS<5:0>						225
SSP2DATPPS	—	—	SSP2DATPPS<5:0>						225
SSP2SSPPS	—	—	SSP2SSPPS<5:0>						225
RX1PPS	—	—	RX1PPS<5:0>						225
TX1PPS	—	—	TX1PPS<5:0>						225
RX2PPS	—	—	RX2PPS<5:0>						225
TX2PPS	—	—	TX2PPS<5:0>						225
RX3PPS	—	—	RX3PPS<5:0>						225
TX3PPS	—	—	TX3PPS<5:0>						225
RX4PPS	—	—	RX4PPS<5:0>						225
TX4PPS	—	—	TX4PPS<5:0>						225
RX5PPS	—	—	RX5PPS<5:0>						225
TX5PPS	—	—	TX5PPS<5:0>						225
RxyPPS	—	—	RxyPPS<5:0>						225

Legend: — = unimplemented, read as '0'. Shaded cells are unused by the PPS module.

20.0 TIMER2/4/6/8 MODULE

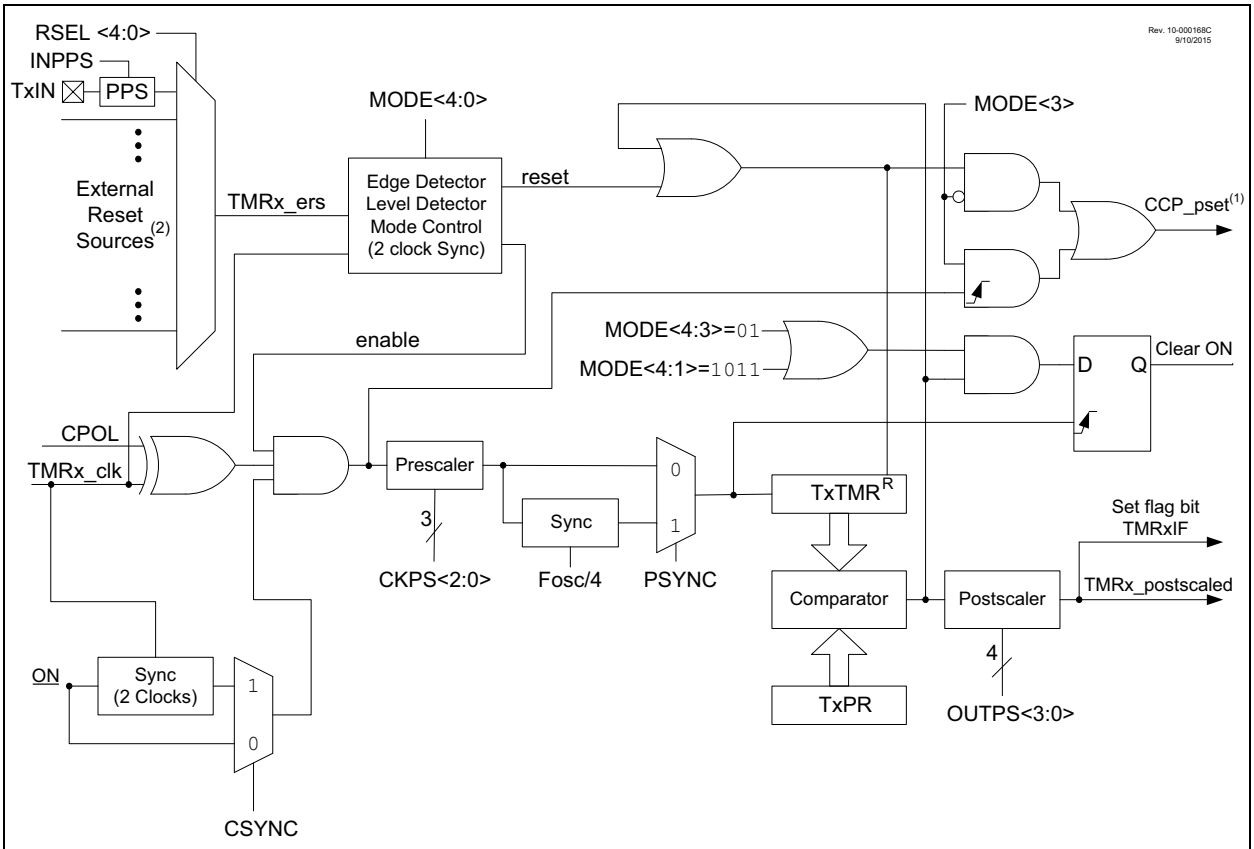
The Timer2/4/6/8 modules are 8-bit timers that can operate as free-running period counters or in conjunction with external signals that control start, run, freeze, and reset operation in One-Shot and Monostable modes of operation. Sophisticated waveform control such as pulse density modulation are possible by combining the operation of these timers with other internal peripherals such as the comparators and CCP modules. Features of the timer include:

- 8-bit timer register
- 8-bit period register
- Selectable external hardware timer Resets
- Programmable prescaler (1:1 to 1:128)
- Programmable postscaler (1:1 to 1:16)
- Selectable synchronous/asynchronous operation
- Alternate clock sources
- Interrupt-on-period
- Three modes of operation:
  - Free Running Period
  - One-shot
  - Monostable

See Figure 20-1 for a block diagram of Timer2. See Figure 20-2 for the clock source block diagram.

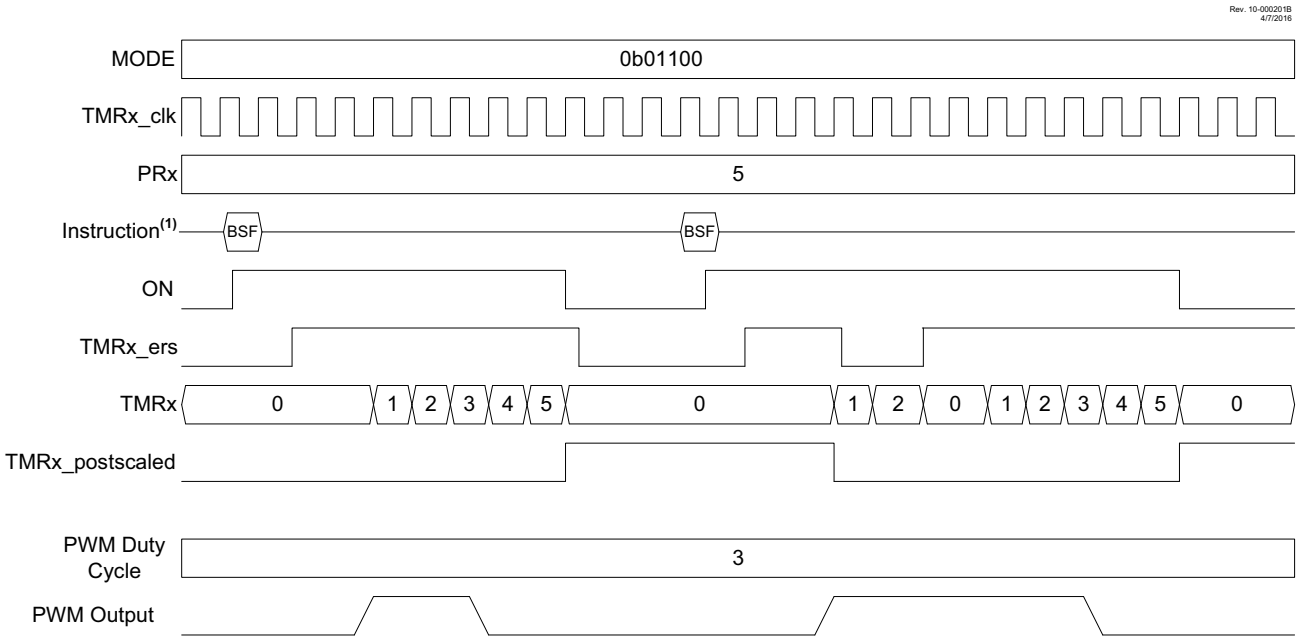
Note:	Four identical Timer2 modules are implemented on this device. The timers are named Timer2, Timer4, Timer6 and Timer8. All references to Timer2 apply as well to Timer4, Timer6 and Timer8. All references to PR2 apply equally to other timers as well.

FIGURE 20-1: TIMER2 BLOCK DIAGRAM



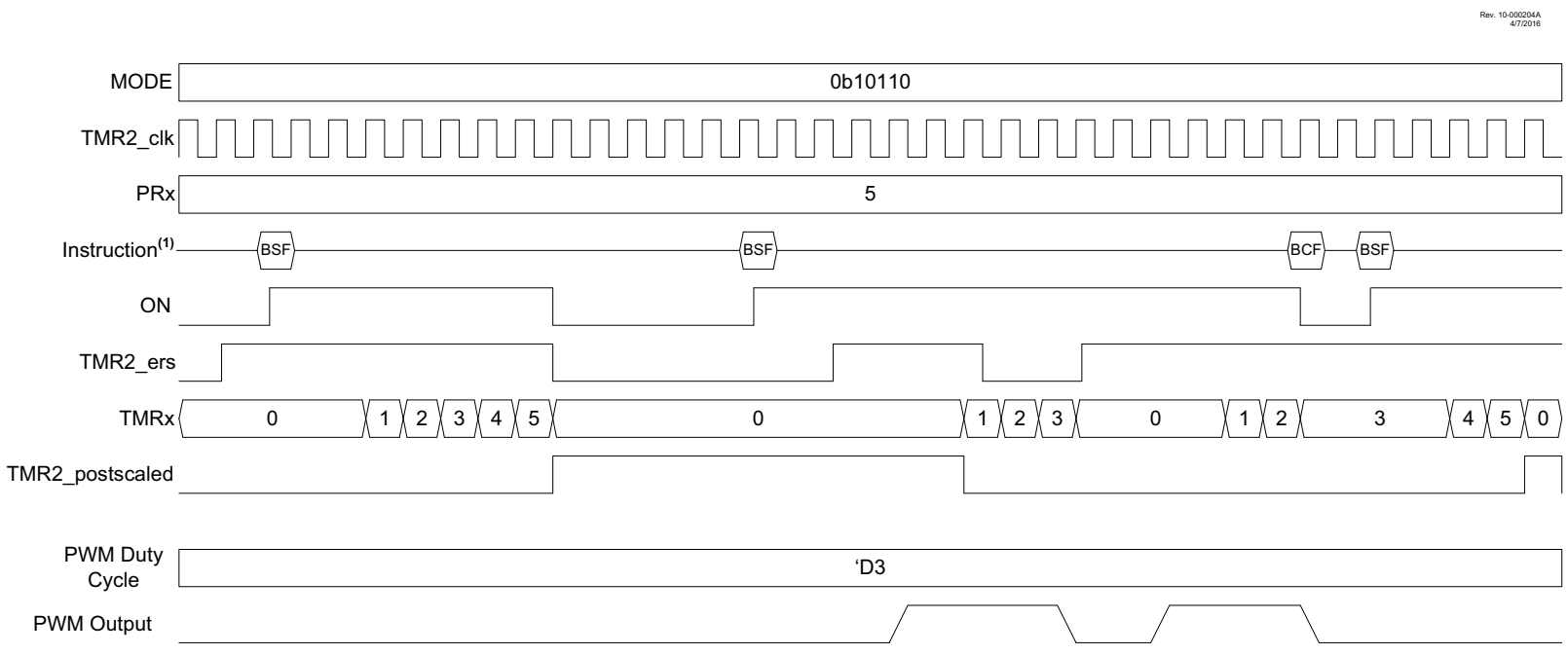
Note 1: Signal to the CCP to trigger the PWM pulse.
2: See Table 20.5 for description of CCP interaction in the different TMR modes.
3: See Table 20.5 for external Reset sources.

FIGURE 20-10: EDGE-TRIGGERED HARDWARE LIMIT ONE-SHOT MODE TIMING DIAGRAM (MODE = 01100)



Note 1: BSF and BCF represent Bit-Set File and Bit-Clear File instructions executed by the CPU to set or clear the ON bit of TxCON. CPU execution is asynchronous to the timer clock input.

FIGURE 20-13: LEVEL-TRIGGERED HARDWARE LIMIT ONE-SHOT MODE TIMING DIAGRAM (MODE = 10110)



Note 1: BSF and BCF represent Bit-Set File and Bit-Clear File instructions executed by the CPU to set or clear the ON bit of TxCON. CPU execution is asynchronous to the timer clock input.

REGISTER 20-4: TxRST: TIMER2 EXTERNAL RESET SIGNAL SELECTION REGISTER

U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—	RSEL<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-4 **Unimplemented:** Read as ‘0’

bit 3-0 **RSEL<3:0>:** Timer2 External Reset Signal Source Selection bits

RSEL<3:0>	TMR2	TMR4	TMR6	TMR8
	Reset Source	Reset Source	Reset Source	Reset Source
1111	ZCD_OUT	ZCD_OUT	ZCD_OUT	ZCD_OUT
1110	CMP3OUT	CMP3OUT	CMP3OUT	CMP3OUT
1101	CMP2OUT	CMP2OUT	CMP2OUT	CMP2OUT
1100	CMP1OUT	CMP1OUT	CMP1OUT	CMP1OUT
1011	PWM7OUT	PWM7OUT	PWM7OUT	PWM7OUT
1010	PWM6OUT	PWM6OUT	PWM6OUT	PWM6OUT
1001	CCP5OUT	CCP5OUT	CCP5OUT	CCP5OUT
1000	CCP4OUT	CCP4OUT	CCP4OUT	CCP4OUT
0111	CCP3OUT	CCP3OUT	CCP3OUT	CCP3OUT
0110	CCP2OUT	CCP2OUT	CCP2OUT	CCP2OUT
0101	CCP1OUT	CCP1OUT	CCP1OUT	CCP1OUT
0100	TMR8 post-scaled	TMR8 post-scaled	TMR8 post-scaled	Reserved
0011	TMR6 post-scaled	TMR6 post-scaled	Reserved	TMR6 post-scaled
0010	TMR4 post-scaled	Reserved	TMR4 post-scaled	TMR4 post-scaled
0001	Reserved	TMR2 post-scaled	TMR2 post-scaled	TMR2 post-scaled
0000	Pin selected by T2INPPS	Pin selected by T4INPPS	Pin selected by T6INPPS	Pin selected by T8INPPS

23.6 Handling VPEAK Variations

If the peak amplitude of the external voltage is expected to vary, the series resistor must be selected to keep the ZCD current source and sink below the design maximum range of ± 600 μA and above a reasonable minimum range. A general rule of thumb is that the maximum peak voltage can be no more than six times the minimum peak voltage. To ensure that the maximum current does not exceed ± 600 μA and the minimum is at least ± 100 μA, compute the series resistance as shown in Equation 23-5. The compensating pull-up for this series resistance can be determined with Equation 23-4 because the pull-up value is independent from the peak voltage.

EQUATION 23-5: SERIES R FOR V RANGE

$$R_{SERIES} = \frac{V_{MAXPEAK} + V_{MINPEAK}}{7 \times 10^{-4}}$$

23.7 Operation During Sleep

The ZCD current sources and interrupts are unaffected by Sleep.

23.8 Effects of a Reset

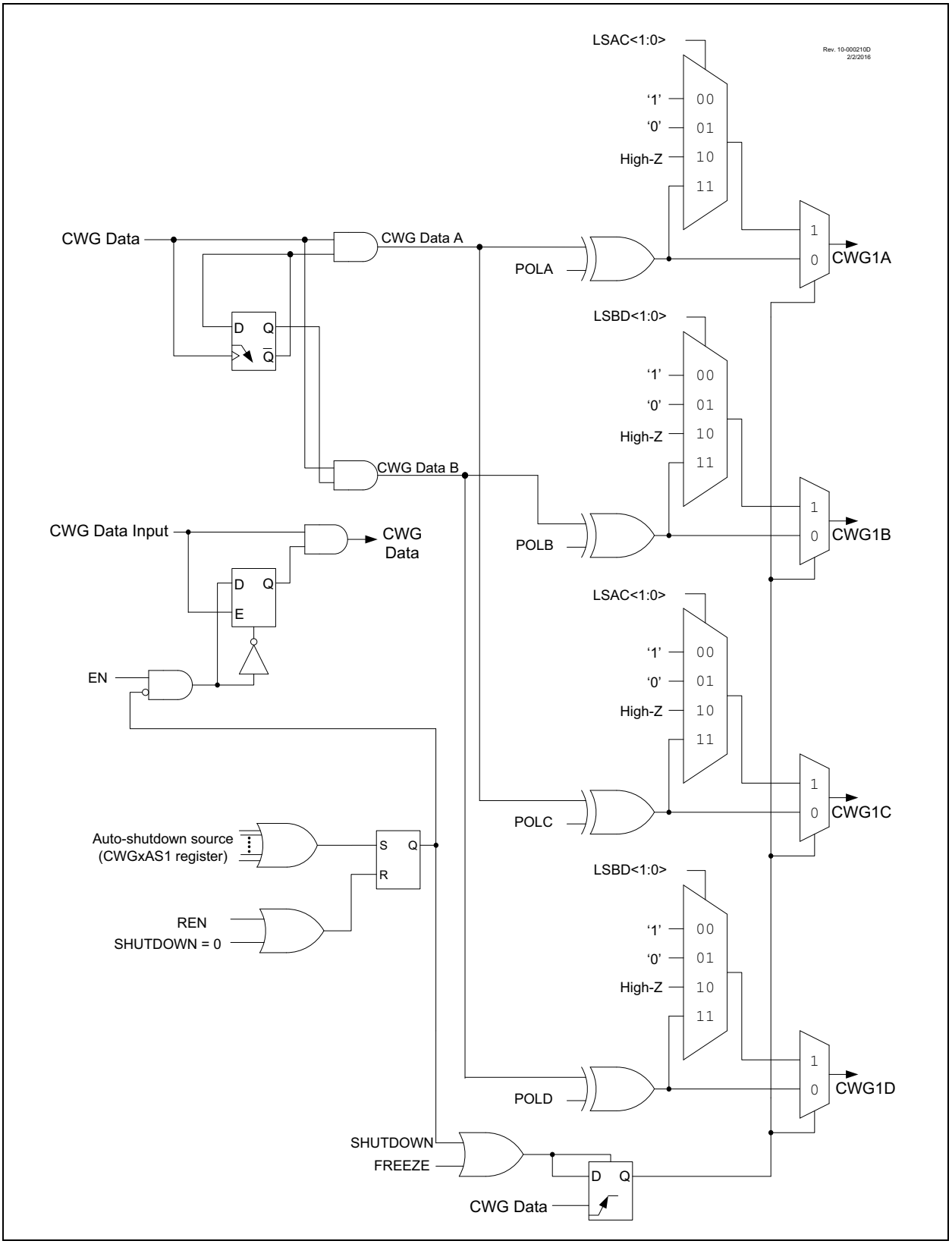
The ZCD circuit can be configured to default to the active or inactive state on Power-on-Reset (POR). When the $\overline{ZCD}$ Configuration bit is cleared, the ZCD circuit will be active at POR. When the $\overline{ZCD}$ Configuration bit is set, the ZCDSEN bit of the ZCDCON register must be set to enable the ZCD module.

23.9 Disabling the ZCD Module

The ZCD module can be disabled in two ways:

1. Configuration Word 2H has the $\overline{ZCD}$ bit which disables the ZCD module when set, but it can be enabled using the ZCDSEN bit of the ZCDCON register (Register 23-1). If the $\overline{ZCD}$ bit is clear, the ZCD is always enabled.
2. The ZCD can also be disabled using the ZCDMD bit of the PMD3 register (Register 7-4). This is subject to the status of the $\overline{ZCD}$ bit.

FIGURE 24-3: SIMPLIFIED CWG BLOCK DIAGRAM (PUSH-PULL MODE, MODE<2:0> = 101)



REGISTER 24-2: CWG1CON1: CWG CONTROL REGISTER 1

U-0	U-0	R-x	U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	IN	—	POLD	POLC	POLB	POLA
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5 **IN:** CWG Input Value bit (read-only)

bit 4 **Unimplemented:** Read as ‘0’

bit 3 **POLD:** CWG1D Output Polarity bit
1 = Signal output is inverted polarity
0 = Signal output is normal polarity

bit 2 **POLC:** CWG1C Output Polarity bit
1 = Signal output is inverted polarity
0 = Signal output is normal polarity

bit 1 **POLB:** CWG1B Output Polarity bit
1 = Signal output is inverted polarity
0 = Signal output is normal polarity

bit 0 **POLA:** CWG1A Output Polarity bit
1 = Signal output is inverted polarity
0 = Signal output is normal polarity

25.7.3 PERIOD AND DUTY-CYCLE MODE

In Duty-Cycle mode, either the duty cycle or period (depending on polarity) of the SMTx_signal can be acquired relative to the SMT clock. The CPW register is updated on a falling edge of the signal, and the CPR register is updated on a rising edge of the signal, along with the SMTxTMR resetting to 0x0001. In addition, the SMTxGO bit is reset on a rising edge when the SMT is in Single Acquisition mode. See Figure 25-6 and Figure 25-7.

When the application software is expecting to receive valid data, the SSPxBUF should be read before the next byte of data to transfer is written to the SSPxBUF. The Buffer Full bit, BF of the SSPxSTAT register, indicates when SSPxBUF has been loaded with the received data (transmission is complete). When the SSPxBUF is read, the BF bit is cleared. This data may be irrelevant if the SPI is only a transmitter. Generally, the MSSP interrupt is used to determine when the transmission/reception has completed. If the interrupt method is not going to be used, then software polling can be done to ensure that a write collision does not occur.

The SSPSR is not directly readable or writable and can only be accessed by addressing the SSPxBUF register. Additionally, the SSPxSTAT register indicates the various Status conditions.

FIGURE 27-3: SPI MASTER/SLAVE CONNECTION

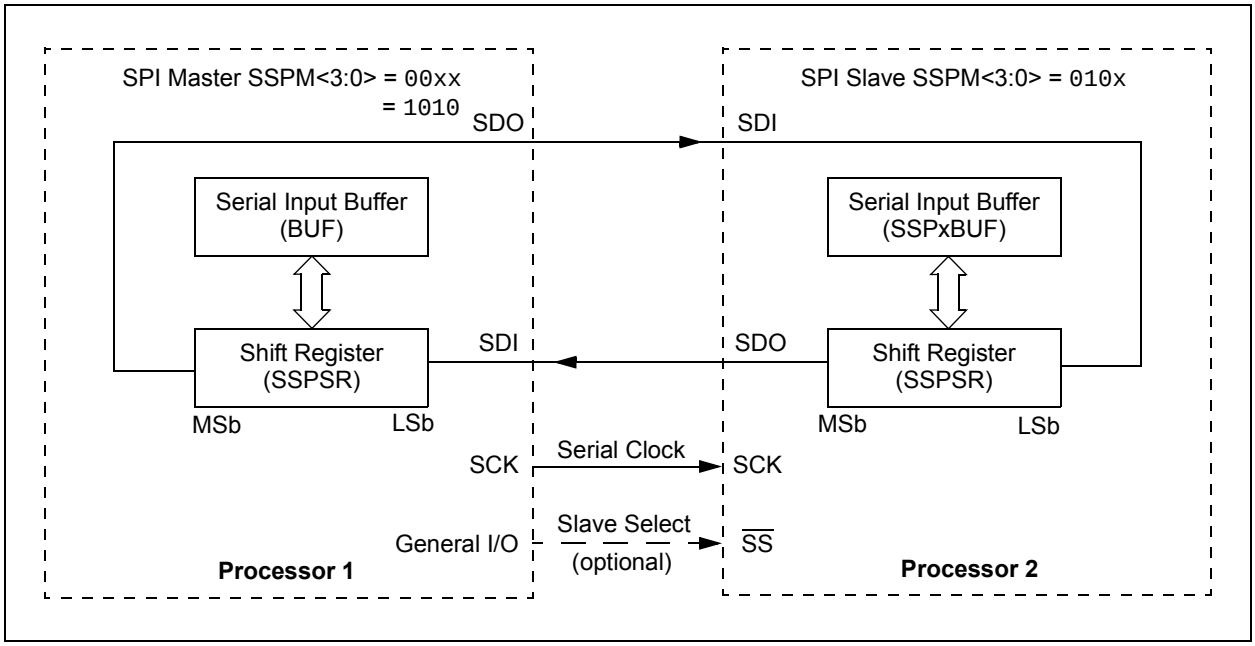
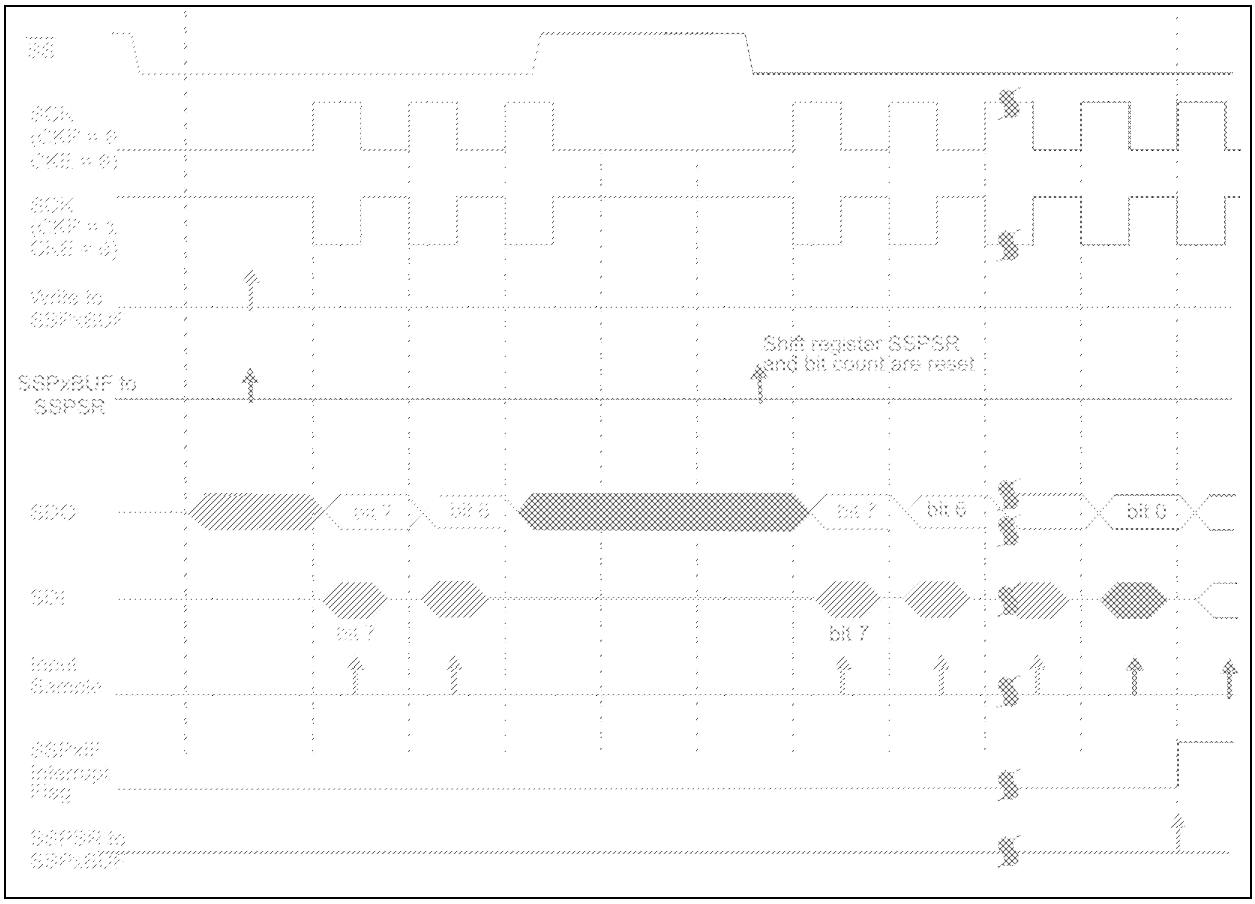


FIGURE 27-6: SLAVE SELECT SYNCHRONOUS WAVEFORM



27.9.8 GENERAL CALL ADDRESS SUPPORT

The addressing procedure for the I^2C bus is such that the first byte after the Start condition usually determines which device will be the slave addressed by the master device. The exception is the general call address which can address all devices. When this address is used, all devices should, in theory, respond with an acknowledge.

The general call address is a reserved address in the I^2C protocol, defined as address 0x00. When the GCEN bit of the SSPxCON2 register is set, the slave module will automatically $\overline{ACK}$ the reception of this address regardless of the value stored in SSPxADD. After the slave clocks in an address of all zeros with the R/$\overline{W}$ bit clear, an interrupt is generated and slave software can read SSPxBUF and respond. Figure 27-24 shows a general call reception sequence.

In 10-bit Address mode, the UA bit will not be set on the reception of the general call address. The slave will prepare to receive the second byte as data, just as it would in 7-bit mode.

If the AHEN bit of the SSPxCON3 register is set, just as with any other address reception, the slave hardware will stretch the clock after the eighth falling edge of SCL. The slave must then set its ACKDT value and release the clock with communication progressing as it would normally.

27.9.9 SSP MASK REGISTER

An SSP Mask (SSPxMSK) register (Register 27-12) is available in I^2C Slave mode as a mask for the value held in the SSPSR register during an address comparison operation. A zero (‘0’) bit in the SSPxMSK register has the effect of making the corresponding bit of the received address a “don’t care”.

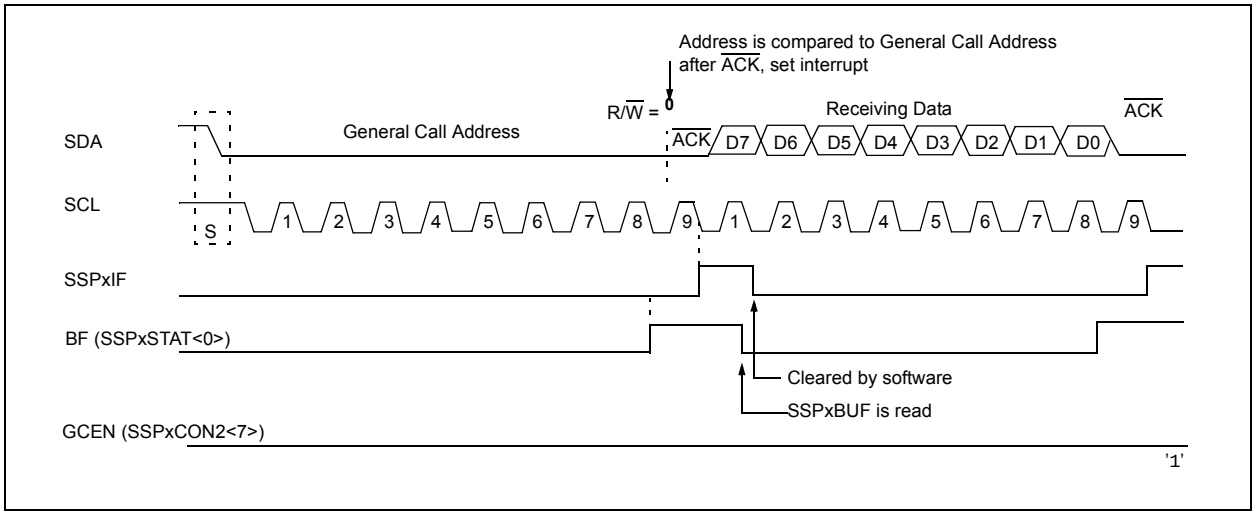
This register is reset to all ‘1’s upon any Reset condition and, therefore, has no effect on standard SSP operation until written with a mask value.

The SSP Mask register is active during:

- 7-bit Address mode: address compare of A<7:1>.

10-bit Address mode: address compare of A<7:0> only. The SSP mask has no effect during the reception of the first (high) byte of the address.

FIGURE 27-24: SLAVE MODE GENERAL CALL ADDRESS SEQUENCE



28.6 EUSART Operation During Sleep

The EUSART will remain active during Sleep only in the Synchronous Slave mode. All other modes require the system clock and therefore cannot generate the necessary signals to run the Transmit or Receive Shift registers during Sleep.

Synchronous Slave mode uses an externally generated clock to run the Transmit and Receive Shift registers.

28.6.1 SYNCHRONOUS RECEIVE DURING SLEEP

To receive during Sleep, all the following conditions must be met before entering Sleep mode:

- RCxSTA and TXxSTA Control registers must be configured for Synchronous Slave Reception (see **Section 28.5.2.4 "Synchronous Slave Reception Setup:"**).
- If interrupts are desired, set the RCxIE bit of the PIE3/4 registers and the GIE and PEIE bits of the INTCON register.
- The RCxIF interrupt flag must be cleared by reading RCxREG to unload any pending characters in the receive buffer.

Upon entering Sleep mode, the device will be ready to accept data and clocks on the RXx/DTx and TXx/CKx pins, respectively. When the data word has been completely clocked in by the external device, the RCxIF interrupt flag bit of the PIR3/4 registers will be set. Thereby, waking the processor from Sleep.

Upon waking from Sleep, the instruction following the SLEEP instruction will be executed. If the Global Interrupt Enable (GIE) bit of the INTCON register is also set, then the Interrupt Service Routine at address 004h will be called.

28.6.2 SYNCHRONOUS TRANSMIT DURING SLEEP

To transmit during Sleep, all the following conditions must be met before entering Sleep mode:

- The RCxSTA and TXxSTA Control registers must be configured for synchronous slave transmission (see **Section 28.5.2.2 "Synchronous Slave Transmission Setup"**).
- The TXxIF interrupt flag must be cleared by writing the output data to the TXxREG, thereby filling the TSR and transmit buffer.
- If interrupts are desired, set the TXxIE bit of the PIE3/4 registers and the PEIE bit of the INTCON register.
- Interrupt enable bits TXxIE of the PIE3 register and PEIE of the INTCON register must set.

Upon entering Sleep mode, the device will be ready to accept clocks on TXx/CKx pin and transmit data on the RXx/DTx pin. When the data word in the TSR has been completely clocked out by the external device, the pending byte in the TXxREG will transfer to the TSR and the TXxIF flag will be set. Thereby, waking the processor from Sleep. At this point, the TXxREG is available to accept another character for transmission, which will clear the TXxIF flag.

Upon waking from Sleep, the instruction following the SLEEP instruction will be executed. If the Global Interrupt Enable (GIE) bit is also set then the Interrupt Service Routine at address 0004h will be called.

REGISTER 32-30: ADUTHH: ADC UPPER THRESHOLD HIGH BYTE REGISTER

R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x
ADUTH<15:8>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADUTH<15:8>**: ADC Upper Threshold MSB. ADLTH and ADUTH are compared with ADERR to set the ADUTHR and ADLTHR bits of ADSTAT. Depending on the setting of ADTMD, an interrupt may be triggered by the results of this comparison.

REGISTER 32-31: ADUTHL: ADC UPPER THRESHOLD LOW BYTE REGISTER

R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x	R/W-x/x
ADUTH<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **ADUTH<7:0>**: ADC Upper Threshold LSB. ADLTH and ADUTH are compared with ADERR to set the ADUTHR and ADLTHR bits of ADSTAT. Depending on the setting of ADTMD, an interrupt may be triggered by the results of this comparison.

33.9 Comparator Response Time

The comparator output is indeterminate for a period of time after the change of an input source or the selection of a new reference voltage. This period is referred to as the response time. The response time of the comparator differs from the settling time of the voltage reference. Therefore, both of these times must be considered when determining the total response time to a comparator input change. See the Comparator and Voltage Reference Specifications in Table 37-15 and Table 37-17 for more details.

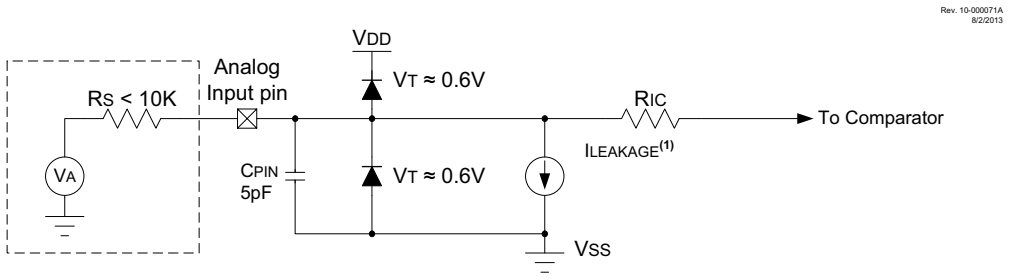
33.10 Analog Input Connection Considerations

A simplified circuit for an analog input is shown in Figure 33-3. Since the analog input pins share their connection with a digital input, they have reverse biased ESD protection diodes to V_{DD} and V_{SS}. The analog input, therefore, must be between V_{SS} and V_{DD}. If the input voltage deviates from this range by more than 0.6V in either direction, one of the diodes is forward biased and a latch-up may occur.

A maximum source impedance of 10 kΩ is recommended for the analog sources. Also, any external component connected to an analog input pin, such as a capacitor or a Zener diode, should have very little leakage current to minimize inaccuracies introduced.

Note 1:	When reading a PORT register, all pins configured as analog inputs will read as a '0'. Pins configured as digital inputs will convert as an analog input, according to the input specification.
2:	Analog levels on any pin defined as a digital input, may cause the input buffer to consume more current than is specified.

FIGURE 33-3: ANALOG INPUT MODEL



Legend: C_{PIN} = Input Capacitance
$I_{LEAKAGE}$ = Leakage Current at the pin due to various junctions
R_{IC} = Interconnect Resistance
R_S = Source Impedance
V_A = Analog Voltage
V_T = Threshold Voltage

Note 1: See **Section 37.0 "Electrical Specifications"**.

38.2 Standard Operating Conditions

The standard operating conditions for any device are defined as:

Operating Voltage: $V_{DDMIN} \leq V_{DD} \leq V_{DDMAX}$
Operating Temperature: $T_{A\_MIN} \leq T_A \leq T_{A\_MAX}$

V_{DD} — Operating Supply Voltage(1)

PIC18LF65/66K40

- V_{DDMIN} (Fosc ≤ 16 MHz) ..... +1.8V
- V_{DDMIN} (Fosc ≤ 32 MHz) ..... +2.5V
- V_{DDMIN} (Fosc ≤ 64 MHz) ..... +3.0V
- V_{DDMAX} ..... +3.6V

PIC18F65/66K40

- V_{DDMIN} (Fosc ≤ 16 MHz) ..... +2.3V
- V_{DDMIN} (Fosc ≤ 32 MHz) ..... +2.5V
- V_{DDMIN} (Fosc ≤ 64 MHz) ..... +3.0V
- V_{DDMAX} ..... +5.5V

T_A — Operating Ambient Temperature Range

Industrial Temperature

- T_{A_MIN} ..... -40°C
- T_{A_MAX} ..... +85°C

Extended Temperature

- T_{A_MIN} ..... -40°C
- T_{A_MAX} ..... +125°C

Note 1: See Parameter Supply Voltage, DS Characteristics: Supply Voltage.